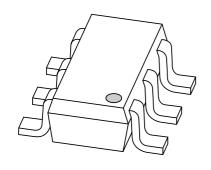
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5350D50 V low V_{CEsat} PNP transistor

Product specification Supersedes data of 2001 Jul 13 2001 Nov 13





50 V low V_{CEsat} PNP transistor

PBSS5350D

FEATURES

- Low collector-emitter saturation voltage
- · High current capability
- Improved device reliability due to reduced heat generation
- Replacement for SOT89/SOT223 standard packaged transistors due to enhanced performance.

APPLICATIONS

- · Supply line switching circuits
- · Battery management applications
- DC/DC convertor applications
- · Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers).

DESCRIPTION

PNP low V_{CEsat} transistor in a SC-74 (SOT457) plastic package.

NPN complement: PBSS4350D.

MARKING

TYPE NUMBER	MARKING CODE		
PBSS5350D	53		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-50	V
I _C	collector current (DC)	-3	Α
I _{CM}	peak collector current	-5	Α
R _{CEsat}	equivalent on-resistance	<150	mΩ

PINNING

PIN	DESCRIPTION	
1	collector	
2	collector	
3	base	
4	emitter	
5	collector	
6	collector	

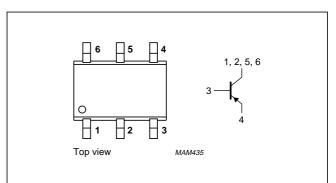


Fig.1 Simplified outline (SC-74; SOT457) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-60	V
V _{CEO}	collector-emitter voltage	open base	_	-50	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
I _C	collector current (DC)		_	-3	Α
I _{CM}	peak collector current		_	- 5	Α
I _{BM}	peak base current		_	-1	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	600	mW
		T _{amb} ≤ 25 °C; note 2	_	750	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 6 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air; note 1	208	K/W
	ambient	in free air; note 2	160	K/W

Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 6 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

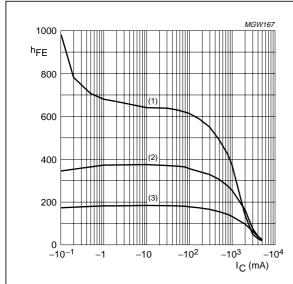
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note } 1$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	100	_	_	
V _{CEsat}	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-100	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	-	_	-180	mV
		$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	_	-300	mV
R _{CEsat}	equivalent on-resistance	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	120	<150	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	-	-1.2	V
V _{BE}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note } 1$	_	_	-1.1	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	40	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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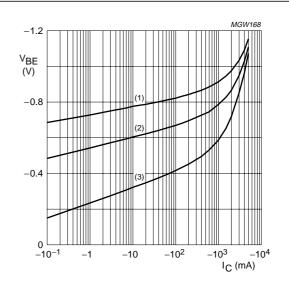
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 $V_{CE} = -2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) T_{amb} = 25 °C.
- (3) $T_{amb} = -55$ °C.

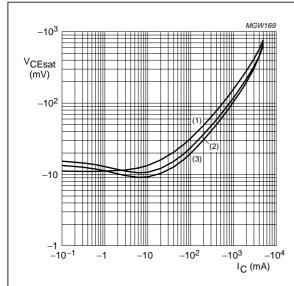
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) T_{amb} = 25 °C.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

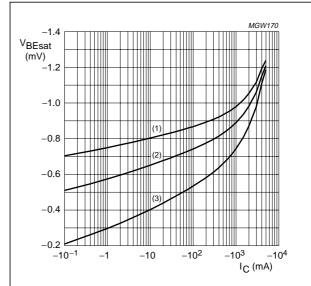
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



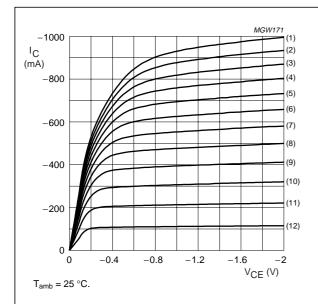
 $I_{\rm C}/I_{\rm B}=10$.

- (1) $T_{amb} = -55 \, ^{\circ}C.$
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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(1) $I_B = -3.96 \text{ nA}.$

(5) $I_B = -2.64 \text{ nA}.$

A. (9) $I_B = -1.32 \text{ nA}$.

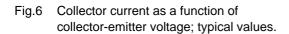
(2) $I_B = -3.63 \text{ nA}.$

(6) $I_B = -2.31 \text{ nA}.$ (7) $I_B = -1.98 \text{ nA}.$ (10) $I_B = -0.99 \text{ nA}$. (11) $I_B = -0.66 \text{ nA}$.

(3) $I_B = -3.30 \text{ nA}.$ (4) $I_B = -2.97 \text{ nA}.$

(8) $I_B = -1.65 \text{ nA}.$

(12) $I_B = -0.33 \text{ nA}.$



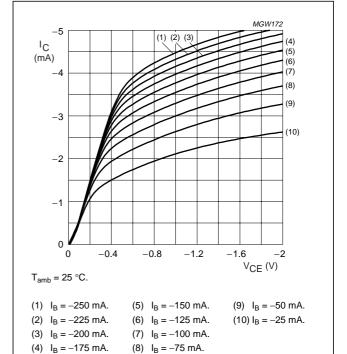
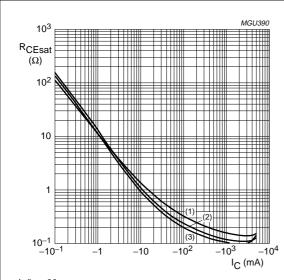


Fig.7 Collector current as a function of collector-emitter voltage; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

(1) $T_{amb} = 150 \,^{\circ}\text{C}$. (2) $T_{amb} = 25 \,^{\circ}\text{C}$. (3) $T_{amb} = -55 \,^{\circ}\text{C}$.

Fig.8 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

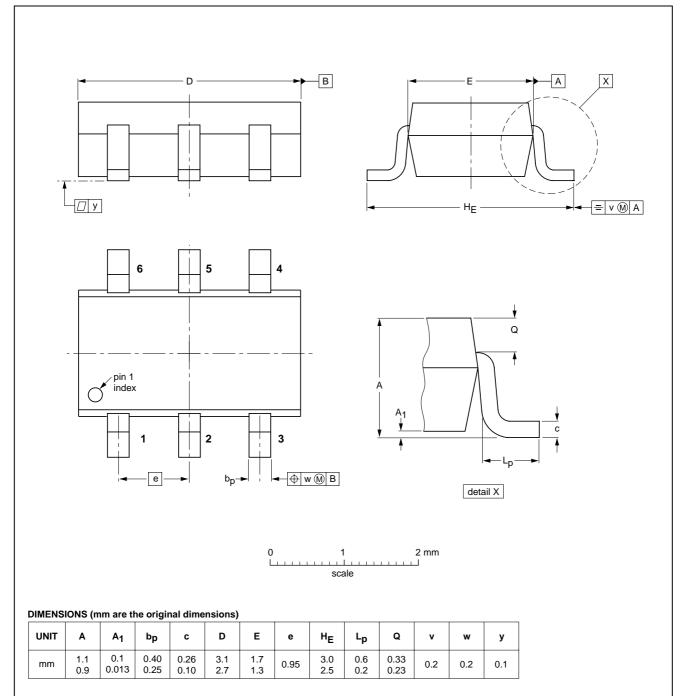
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



REFERENCES

EIAJ

SC-74

JEDEC

EUROPEAN

PROJECTION

ISSUE DATE

97-02-28

01-05-04

2001 Nov 13 7

IEC

OUTLINE VERSION

SOT457

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